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U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM 10029764	FILING DATE 10/22/2001	CLASS 438	SUBCLASS 685	GAU 2824	EXAMINER FLAN William
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**APPLICANTS: Yang Wen-Kun; Mou Eddy;

**CONTINUING DATA VERIFIED:
THIS APPLICATION IS A CIP OF 09/846,468 04/30/2001

not correct #

** FOREIGN APPLICATIONS VERIFIED:

PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no	6033.P075
Verified and Acknowledged Examiners's initials	
TITLE : Wafer level package and the process of the same	

U.S. DEPT. OF COMM./PAT. & TM.-PTO-438 (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
ISSUE FEE		Total Claims	
Amount Due	Date Paid	Print Claim for O.G.	
<input type="checkbox"/> TERMINAL DISCLAIMER		DRAWING	
		Sheets Drawg.	Print Fig.
		Figs. Drawg.	
		Application Examiner	
		PREPARED FOR ISSUE	
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